

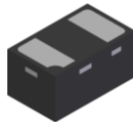
Features

- Fast Switching Speed
- Ultra-Small Surface Mount Package
- For General Purpose Switching Applications
- High Breakdown Voltage
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

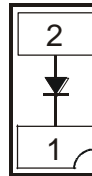
Mechanical Data

- Case: X1-DFN1006-2
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Marking Information
- Terminals: Finish - NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 Ⓔ4
- Weight: 0.001 grams (Approximate)

X1-DFN1006-2



Bottom View



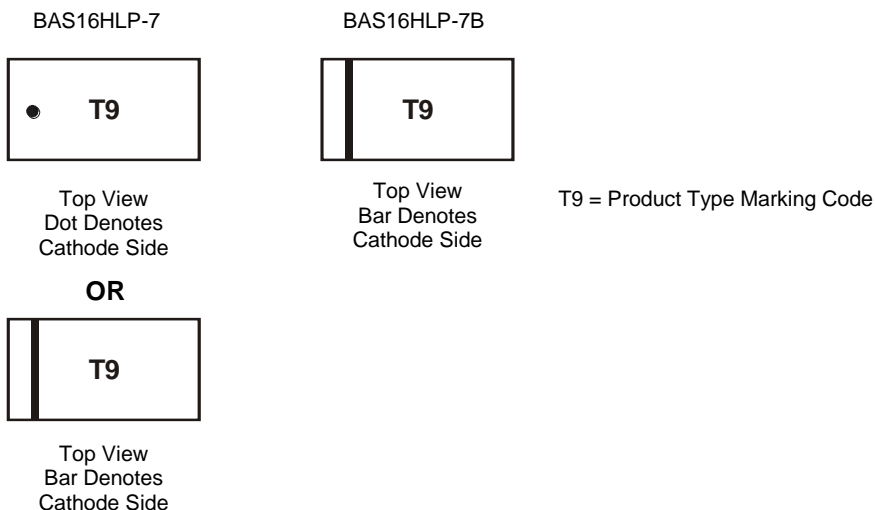
Device Schematic

Ordering Information (Note 4)

| Part Number | Case | Packaging |
|-------------|--------------|--------------------|
| BAS16HLP-7 | X1-DFN1006-2 | 3,000/Tape & Reel |
| BAS16HLP-7B | X1-DFN1006-2 | 10,000/Tape & Reel |

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit |
|-------------------------------------------|---------------------|-------------|------|
| Non-Repetitive Peak Reverse Voltage | V _{RM} | 125 | V |
| Peak Repetitive Reverse Voltage | V _{RRM} | 100 | V |
| Working Peak Reverse Voltage | V _{RWM} | | |
| DC Blocking Voltage | V _R | | |
| RMS Reverse Voltage | V _{R(RMS)} | 71 | V |
| Forward Continuous Current | I _{FM} | 215 | mA |
| Non-Repetitive Peak Forward Surge Current | I _{FSM} | @ t = 1.0μs | 4 |
| | | @ t = 1.0ms | 1 |
| | | @ t = 1.0s | 0.5 |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|-------------------------------------------------|-----------------------------------|-------------|------|
| Power Dissipation (Note 5) | P _D | 250 | mW |
| Thermal Resistance Junction to Ambient (Note 5) | R _{θJA} | 500 | °C/W |
| Operating and Storage Temperature Range | T _J , T _{STG} | -65 to +150 | °C |

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Max | Unit | Test Conditions |
|------------------------------------|--------------------|-----|-------|------|-----------------------------------------------------------------------------------------------------------|
| Reverse Breakdown Voltage (Note 6) | V _{(BR)R} | 100 | — | V | I _R = 100μA |
| Forward Voltage | V _F | — | 0.715 | V | I _F = 1.0mA |
| | | — | 0.855 | | I _F = 10mA |
| | | — | 1.0 | | I _F = 50mA |
| | | — | 1.25 | | I _F = 150mA |
| Peak Reverse Current (Note 6) | I _R | — | 500 | nA | V _R = 80V |
| | | — | 50 | μA | V _R = 80V, T _J = +150°C |
| | | — | 30 | μA | V _R = 25V, T _J = +150°C |
| | | — | 30 | nA | V _R = 25V |
| Total Capacitance | C _T | — | 1.5 | pF | V _R = 0V, f = 1.0MHz |
| Reverse Recovery Time | t _{rr} | — | 4.0 | ns | I _F = I _R = 10mA, I _{rr} = 0.1 x I _R , R _L = 100Ω |

Notes: 5. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at <http://www.diodes.com>.
6. Short duration pulse test used to minimize self-heating effect.

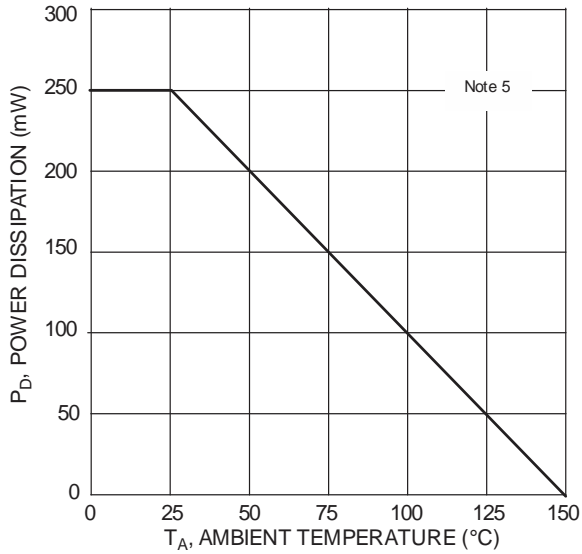


Fig. 1 Power Derating Curve

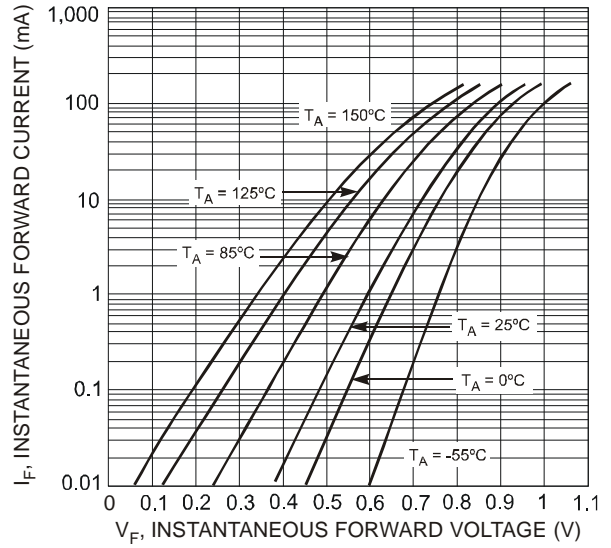


Fig. 2 Typical Forward Characteristics

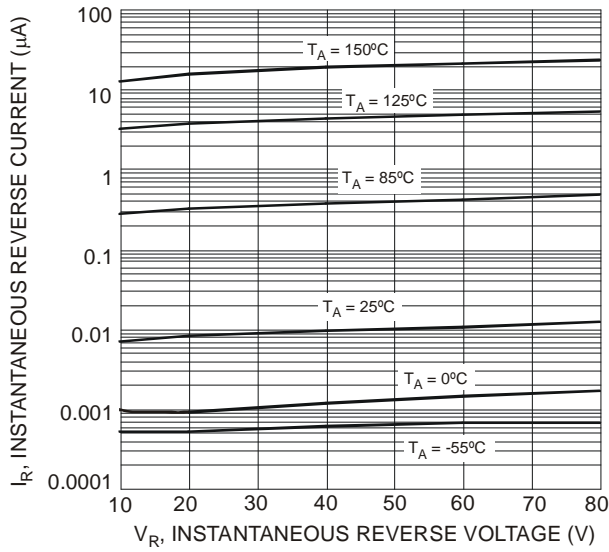


Fig. 3 Typical Reverse Characteristics

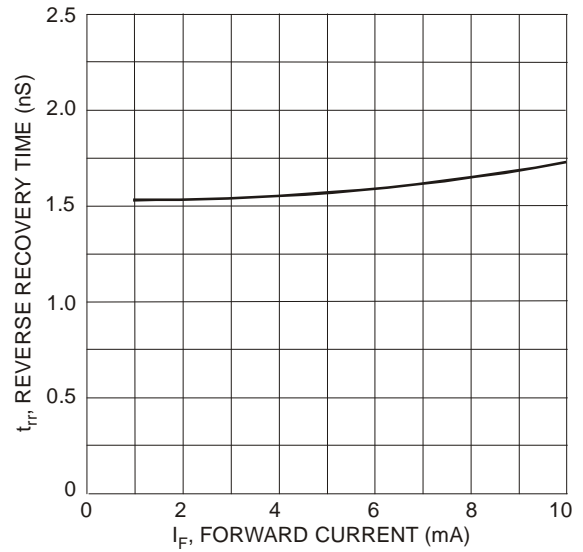


Fig. 4 Reverse Recovery Time vs. Forward Current

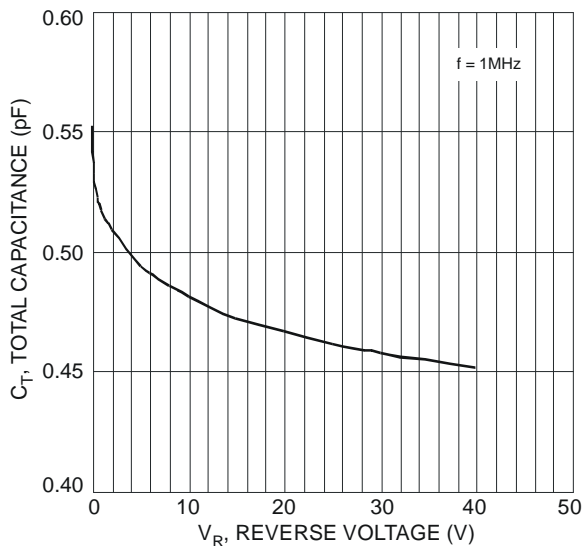
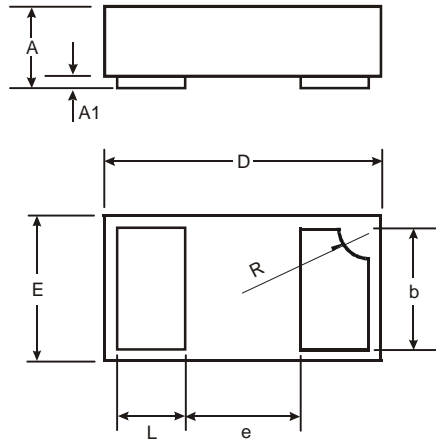


Fig. 5 Typical Total Capacitance

Package Outline Dimensions

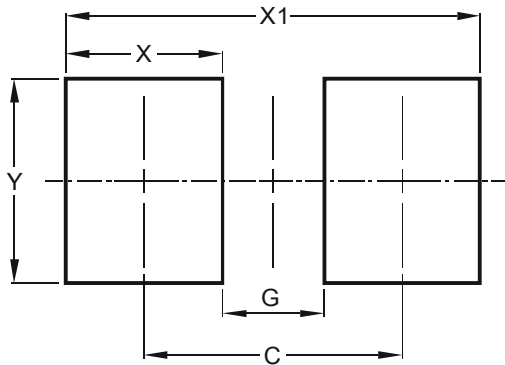
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



| X1-DFN1006-2 | | | |
|----------------------|------|-------|------|
| Dim | Min | Max | Typ |
| A | 0.47 | 0.53 | 0.50 |
| A1 | 0 | 0.05 | 0.03 |
| b | 0.45 | 0.55 | 0.50 |
| D | 0.95 | 1.075 | 1.00 |
| E | 0.55 | 0.675 | 0.60 |
| e | - | - | 0.40 |
| L | 0.20 | 0.30 | 0.25 |
| R | 0.05 | 0.15 | 0.10 |
| All Dimensions in mm | | | |

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| C | 0.70 |
| G | 0.30 |
| X | 0.40 |
| X1 | 1.10 |
| Y | 0.70 |

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